



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Salman Akram

Serial No.: 10/791,191

Filed: March 2, 2004

For: METHOD OF IMPROVING COPPER
INTERCONNECTS OF
SEMICONDUCTOR DEVICES FOR
BONDING

Confirmation No.: 1968

Examiner: L. Gurley

Group Art Unit: 2812

Attorney Docket No.: 2269-3854.3US
(98-0854.03/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

June 23, 2005
Date

Leta M. Howard
Signature

Leta M. Howard
Name (Type/Print)

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AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This amendment is in response to the Office Action of March 23, 2005 whose initial period of response is set to expire on June 23, 2005.

Amendments to the Specification begin on page 3 of this paper.

Amendments to the Drawings begin on page 12 of this paper and include attached replacement and annotated drawing sheets.

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Amendments to the Claims are reflected in the listing of claims which begins on page 13 of this paper.

Remarks/Arguments begin on page 16 of this paper.

An **Appendix** including replacement and annotated drawing sheets is attached following page __ of this paper.